

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of : **Eiki HASHIMOTO**
Filed: : Concurrently herewith
For: : **A SEMICONDUCTOR CIRCUIT DESIGNING.....**
Serial No. : Concurrently herewith

Assistant Commissioner of Patents
Washington, D.C. 20231

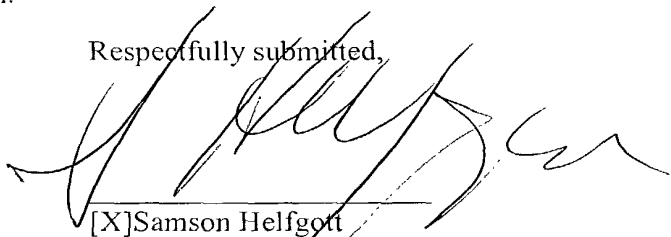
November 16, 2001

SUB-POWER OF ATTORNEY

S I R:

I, Samson Helfgott Reg. No. 23,072 attorney of record herein, do hereby grant a sub-power of attorney to Linda S. Chan, Reg. No. 42,400, Harris A. Wolin, Reg. No. 39,432, Brian S. Myers, Reg. No. 46,947, Michael Markowitz, Reg. No. 30,659, Shahan Islam, Reg. No. 32,507, Emma Shleifer, Reg. No. 29,734 and Serle Mosoff, Reg. No. 25,900 to act and sign in my behalf in the above-referenced application.

Respectfully submitted,



[X]Samson Helfgott
Reg.No. 23,072
[]Aaron B. Karas
Reg. No. 18,923

Rosenman & Colin LLP
575 Madison Avenue
New York, NY 10022-2585
DOCKET NO.: **NEKU 19.181**

UNITED STATES

DECLARATION FOR PATENT APPLICATION

Docket No. NEKU 19.181

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled A SEMICONDUCTOR CIRCUIT DESIGNING APPARATUS AND A SEMICONDUCTOR CIRCUIT DESIGNING METHOD IN WHICH THE NUMBER OF STEPS IN A CIRCUIT DESIGN AND A LAYOUT DESIGN IS REDUCED

the specification of which

(check one)

☒ is attached hereto

☐ was filed on _____ as

Application Serial No. _____

and was amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations { 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, { 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

(Number)	(Country)	(Day/Month/Year Filed)	Priority Claimed
354306/2000	Japan	21/11/2000	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
(Number)	(Country)	(Day/Month/Year Filed)	Yes No
(Number)	(Country)	(Day/Month/Year Filed)	Yes No

I hereby claim the benefit under Title 35, United States Code { 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, { 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations { 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
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(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
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I hereby appoint as my attorney and agent **Aaron B. Karas, Reg. No. 18,923, Samson Helfgott, Reg. No. 23,072, Leonard Cooper, Reg. No. 27,625 and Emma Shleifer, Reg. No. 29,734** to prosecute this application and to transmit all business in the Patent and Trademark Office connected therewith.

Address all correspondence to:

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New York, New York 10118-0110
Telephone No.: (212) 643-5000

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor EIKI HASHIMOTO

Inventor's Signature Eiki Hashimoto Date November 7, 2001

Residence Kanagawa, Japan Citizenship Japanese

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